

In the United States Patent and Trademark Office

In re the application of	TI-25300.2
Application No.10/806,539	Art Unit: 2138
Filed: 3/23/2004	Examiner: S. Radosevich
Title: Probeless Testing of Pad Buffers on Wafer	

Amendment E Under 37 CFR 1.312

June 7, 2007

Asst. Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313

Dear Sir:

Responsive to the Supplemental Notice of Allowability of 05/18/2007, please amend this application as follows: